Quasi-Resonant Buck Controller for Precise Current Regulation and Wide Analog Dimming

NCL30076

The NCL30076 is a DC-DC buck controller for wide dimming range down to 1% by analog dimming control to relieve audible noise and flicker in PWM dimming. ON Semiconductor's proprietary LED current calculation technique driven by zero input offset amplifiers performs precise constant current in the whole analog dimming range. Multi-mode operation provides high efficiency with minimized switching loss by QR at heavy load and deep analog dimming by DCM at light load.

PWM dimming control is also provided in case that constant LED color temperature is required. The NCL30076 has several protections such as LED short protection, over current protection, thermal shutdown and VDD over voltage protection for robust system reliability.

Features

- Wide Analog Dimming Range: 1~100%
- Low CC Tolerance: ±2% at 100% Load & ±20% at 1% Load
- Low System BOM
- LED Off Mode at Standby
- Low Standby Current
- PWM Dimming Available
- Gate Sourcing and Sinking Current of 0.5 A/0.8 A
- Robust Protection Features
 - LED Short Protection
 - Over Current Protection
 - Thermal Shutdown
 - V_{DD} Over Voltage Protection

Typical Applications

• LED Lighting System



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SOIC-8 NB **CASE 751**

MARKING DIAGRAM



AA

YYWW

А WL



= 4 Digit Data Code

PIN ASSIGNMENT



ORDERING INFORMATION

Device	Package	Shipping
NCL30076AADR2G	SOIC-8 NB	3000 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

APPLICATION SCHEMATIC



Figure 1. Application Schematic

BLOCK DIAGRAM





PIN CONFIGURATION



Figure 3. Pin Configuration

PIN FUNCTION DESCRIPTION

Pin No.	Pin Name	Function	Description
1	BIAS	3.3 V BIAS	This pin is 3.3 V LDO output to bias the internal digital circuit
2	CSZCD	CS and ZCD Sensing	This pin detects the switch current and the inductor current zero cross time
3	SG	Signal Ground	Signal Ground is close to control pin circuit such as CSZCD, DIM and FB
4	FB	Feedback	Output of feedback OTA
5	DIM	Dimming Input	Dimming signal is provided to this pin
6	VDD	Power Supply	IC operating current is supplied to this pin
7	DRV	Output Drive	This pin is connected to drive external switch
8	PG	Power Ground	Power Ground is close to the capacitors at BIAS and VDD pin

SPECIFICATIONS

MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
VDD, DRV Pin Voltage Range	V _{MV(MAX)}	-0.3 to 30	V
DIM, FB, CSZCD, BIAS Pin Voltage Range	V _{LV(MAX)}	-0.3 to 5.5	V
Maximum Power Dissipation ($T_A < 50^{\circ}C$)	P _{D(MAX)}	550	mW
Maximum Junction Temperature	T _{J(max)}	150	°C
Storage Temperature Range	T _{STG}	-55 to 150	°C
Junction-to-Ambient Thermal Impedance	R _{θJA}	145	°C/W
ESD Capability, Human Body Model (Note 2)	ESD _{HBM}	2	kV
ESD Capability, Charged Device Model (Note 2)	ESD _{CDM}	1	kV

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Refer to ELECTRICAL CHARACTERISTICS, RECOMMENDED OPERATING RANGES and/or APPLICATION INFORMATION for Safe Operating parameters.

2. This device series incorporates ESD protection and is tested by the following methods:

ESD Human Body Model per JEDEC Standard JESD22–A114
 ESD Charged Device Model per JEDEC Standard JESD22–C101

- Latch-up Current Maximum Rating ±100 mA per JEDEC Standard JESD78

RECOMMENDED OPERATING RANGES

Standby Enabling DIM Voltage

Standby Disabling DIM Voltage

Standby Delay Time

Parameter	Symbol	Min	Max	Unit
Junction Temperature	TJ	-40	125	°C

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

ELECTRICAL CHARACTERISTICS (V_{DD} = 15 V and T_J = -40~125°C unless otherwise specified)

Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit
VDD SECTION	•					
IC Turn–On Threshold Voltage		V _{DD(ON)}	9.3	10.0	10.7	V
IC Turn–Off Threshold Voltage		V _{DD(OFF)}	7.4	8.0	8.6	V
Startup Current $V_{DD} = V_{DD(ON)} - 1.6 V$		I _{DD(ST)}	-	250	400	μΑ
Operating Current		I _{DD(OP)}	-	6.5	8.0	mA
Standby Current		I _{DD(SB)}	-	200	300	μΑ
BIAS SECTION						
BIAS Voltage		V _{BIAS}	3.23	3.30	3.37	V
	T _J = 25~100°C (Note 4)		3.25	3.30	3.35	
DIM SECTION						
DIM Voltage for 100% V _{REF}	V _{DIM} = 1.9 V	V _{DIM(REF-MAX)}	1.755	1.80	1.845	V
DIM Voltage for 99% V _{REF}		V _{DIM(MAX-EFF)}	1.730	1.78	1.827	V

50

60

9

V_{DIM(SB-ENA)}

V_{DIM(SB-DIS)}

t_{SB(DELAY)}

75

100

10

100

140

11

mV

m٧

ms

Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit
FB SECTION	-	- -			-	-
FB OTA Source Current		I _{FB(SOURCE)}	-14.0	-11.5	-9.0	μΑ
FB OTA Sink Current	$\label{eq:linear} \begin{array}{l} IFB = (V_{LED} - V_{REF}) \ x \ g_{M(FB)} \ x \ 10 \\ V_{REF} = 50 \ mV, \ V_{LED} = 100 \ mV \end{array}$	I _{FB(SINK)}	9.0	11.5	14.0	μΑ
FB OTA Transconductance	$g_{M(FB)} = I_{FB} / \{(V_{REF} - V_{LED}) \times 10\}$	9м(FB)	18	23	28	μmho
FB OTA High Voltage	V_{REF} = 150 mV, V_{LED} = 100 mV	V _{FB(HIGH)}	4.7	-	-	V
FB Minimum Clamping Voltage	$V_{REF} = 0 \text{ mV}, V_{LED} = 100 \text{ mV}$	V _{FB(CLP)}	0.4	0.5	0.6	V
CS SECTION						
CS Regulation		V _{CS(REG-MAX)}	155	160	165	mV
CS Current Limit Maximum		V _{CS(LIM-MAX)}	390	410	430	mV
CS Current Limit Minimum		V _{CS(LIM-MIN)}	145	155	165	mV
DUTY SECTION						
Leading Edge Blanking Time at Turn-on		t _{LEB(TON)}	360	400	440	ns
Maximum Ton Time		t _{ON(MAX)}	45	50	55	μs
Minimum Toff Time	V _{FB} = 3.8 V	t _{OFF(MIN)}	900	1250	1500	ns
Maximum Toff Time	V _{FB} = 0.5 V	t _{OFF(MAX)}	1.17	1.30	1.43	ms
Maximum FB Voltage for Min. Toff		V _{FB(MAX-TOFF)}	3.30	3.43	3.55	V
Minimum FB Voltage for Max. Toff		V _{FB(MIN-TOFF)}	0.9	1.1	1.3	V
Quasi-Resonant Delay Time		t _{QR}	0.45	0.50	0.55	μs
DRV SECTION						
DRV Low Voltage		V _{DRV(LOW)}	-	-	0.2	V
DRV High Voltage	V _{DD} = 15 V	V _{DRV(HIGH)}	11	12	13	V
DRV Rising Time	C _{DRV} = 3.3 nF	t _{DRV(R)}	60	100	145	ns
DRV Falling Time	C _{DRV} = 3.3 nF	t _{DRV(F)}	25	55	105	ns
AUTO RESTART SECTION						
Auto Restart Time at Protection		t _{AR(PROT)}	0.9	1.0	1.1	s
VDD OVER VOLTAGE PROTECTION	SECTION					
VDD Over Voltage Threshold Voltage		V _{DD(OVP)}	22	23	24	V
OVER CURRENT PROTECTION SEC	TION					
CS Over Current Protection Threshold		V _{CS(OCP)}	0.9	1.0	1.1	V
THERMAL SHUTDOWN SECTION						
Thermal Shut Down Temperature (Note 3)		T _{SD}	130	150	170	°C
Thermal Shut Down Hysteresis	1	T _{SD(HYS)}	25	30	35	°C

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.
Guaranteed by design.
Guaranteed by characterization.

TYPICAL CHARACTERISTICS

(These characteristic graphs are normalized at T_{A} = 25°C)







Figure 5. V_{DIM(MAX)} vs. Temperature



Figure 6. $g_{M(FB)}$ vs. Temperature



Figure 7. V_{CS(REG-MAX)} vs. Temperature







Figure 9. V_{DD(OVP)} vs. Temperature

APPLICATION INFORMATION

General

NCL30076 provides wide analog dimming down to 1% with accurate CC regulation. According to buck inductor, input voltage and output voltage, deep dimming down to $0.1 \sim 0.2\%$ load can be achieved. Thanks to ON Semiconductor's proprietary LED current calculation technique, NCL30076 is able to sense the current of LED load connected at input voltage node with no upper limit of the input voltage with high design flexibility and system reliability. LED current sensed by internal zero input offset amplifiers performs accurate CC regulation in the whole analog dimming range. Therefore, CC tolerance is tightly controlled within $\pm 2\%$ at 100% load and $\pm 20\%$ at 1% load.

Wide Analog Dimming

Wide analog dimming range is obtained by transitioning multi-mode operation between QR and DCM according to the dimming condition. At full load condition, QR with valley switching minimizes switching loss for high system efficiency and DCM is activated at light load condition to perform deep analog dimming. Internal LED current calculator and a digital compensator provide dimming linearity over the entire dimming range.

PWM Dimming

Analog dimming has benefits for less audible noise and flicker compared to PWM dimming. However, PWM dimming method is generally required to keep the constant LED color temperature in specific applications. NCL30076 supports PWM diming by simply providing PWM dimming signal to DIM pin.

Precise CC Regulation

CC regulation is very important especially in programmable LED driver system to keep constant LED current under system variation of LED load, inductor, temperature, etc. NCL30076 applies zero input offset amplifiers at LED current calculator and OTA. Those blocks can implement precise LED current sensing and FB voltage generation. Therefore, NCL30076 supports low CC tolerance less than $\pm 2\%$ at full load and $\pm 20\%$ at 1% load in the system variation.

Soft start

At startup, an internal soft start block gradually reduces T_{OFF} time from maximum T_{OFF} limit so that LED current is settled smoothly without overshoot current and unexpected flash.

Standby Mode

When V_{DIM} is lower than a standby threshold voltage for 10 ms, standby mode is triggered with LED turn–off and IC current consumption is minimized.

Auto Restart (AR) at Protection

Once protection is triggered, IC operation stops for 1 second and begins soft start operation after the auto restart time delay.

VDD Over Voltage Protection (OVP)

When VDD is higher than $V_{DD (OVP)}$ threshold, over voltage protection is triggered.

Short LED Protection (SLP)

When LED is short circuited, the buck stage operates at minimum switching frequency, so the maximum turn-off time control protects the freewheeling diode from thermal stress.

Over Current Protection (OCP)

When CSZCD voltage exceeds the over current threshold voltage, switching is immediately shut down after leading edge blanking time in the short circuit condition of the inductor or the freewheeling diode.

Thermal Shot Down (TSD)

When IC junction temperature is higher than 150°C, TSD is triggered and released when the temperature is lower than 120°C.

BASIC OPERATION

NCL30076 is the current mode buck controller in which DRV is off when V_{CSZCD} reaches to $V_{CS.LIM}$ and DRV is on by inductor current zero cross signal ($V_{TOFF.ZCD}$) in QR and $T_{OFF.FB}$ generator output ($V_{TOFF.FB}$) in DCM as shown in Figure 10. V_{LED} is calculated based on V_{CSZCD} in precise LED current calculator block composed of zero input offset amplifiers and V_{REF} is controlled by DIM signal by below equation.

$$V_{\text{REF}}[V] = \frac{V_{\text{DIM}} - 0.2 V}{10}$$
 (eq. 1)

 V_{LED} is compared with V_{REF} by OTA to generate V_{FB} . V_{FB} sets $V_{CS.LIM}$ as below equation.

$$V_{CS.LIM} [V] = \frac{V_{FB}}{10} + 37.5 \text{ mV}$$
 (eq. 2)

 V_{FB} also controls $V_{TOFF,FB}$ signal by $T_{OFF,FB}$ generator in which $V_{TOFF,FB}$ is triggered at $T_{OFF,FB}$ after DRV is turned off.

$$T_{OFF.FB} \left[\mu s \right] \, = \, \frac{2.7}{V_{FB} - \, 1.1} \, + \, 0.1 \tag{eq. 3} \label{eq:eq.3}$$

When V_{CSZCD} drops after the inductor current zero cross, IC counts t_{QR} (0.5 µs) and trigger $V_{TOFF,ZCD}$. In QR mode, $V_{TOFF,ZCD}$ signal is generated later than $V_{TOFF,FB}$ signal and DRV on is determined by $V_{TOFF,ZCD}$ for valley switching. In DCM mode, DRV on is set by $V_{TOFF,FB}$ as $T_{OFF,FB}$ is longer than $V_{TOFF,ZCD}$ triggering time.



Figure 10. NCL30076 Block Diagram

Wide Analog Dimming

NCL30076 operates in QR at full load and in DCM at light load for a wide dimming range. Figure 11 shows how NCL30076 operates with V_{DIM} .



Figure 11. Operation Mode vs. V_{DIM}

- <u>A:</u> V_{FB} controls V_{CS.LIM} and T_{OFF} is determined by T_{OFF.ZCD} with QR switching as T_{OFF.ZCD} is longer than T_{OFF.FB}.
- <u>B:</u> Operating mode is transitioned from QR to DCM at the boundary between A and B region which is approximately half load. T_{OFF} is determined by T_{OFF.FB} as T_{OFF.FB} is longer than T_{OFF.ZCD}. When V_{DIM} is further reduced, V_{CS.LIM} is no longer controlled by V_{FB} and clamped to minimum V_{CS.LIM} (155 mV).
- <u>C</u>: When V_{DIM} is lower than 0.2 V, V_{REF} is set to 0 V and V_{FB} is pulled down to 0.5 V clamping voltage with min. LED current under open loop control. When V_{DIM} is lower than 0.075/0.1 V, standby mode is triggered with LED turn–off.

Precise CC Regulation

Current sensing amplifier and OTA applies zero input offset compensation technique for precise CC regulation and dimming curve linearity in multi–mode operation

Table 1 shows CC tolerance measured by changing inductor ($\pm 15\%$), temperature (-10, 25, 90 °C), output voltage (100, 200, 300 V) and controller 150 pcs (3 lot variation) in 400 V input 100 W driver. As a result, CC tolerance with system variables at 1% deep dimming condition is less than $\pm 26\%$ and less than $\pm 3.0\%$ at full load condition.

Inductor : ±15%						
Temp. : –10 / 25 / 90 °C	100% Load	50% Load	10% Load	5% Load	2% Load	1% Load
V _{OUT} : 100 V	1.99	3.77	4.41	5.32	9.22	16.23
V _{OUT} : 200 V	1.83	3.70	4.76	5.23	8.64	14.44
V _{OUT} : 300 V	1.86	3.06	4.33	5.80	10.57	20.54*
V _{OUT} : 100 / 200 / 300 V	2.29	4.10	5.45	6.94	13.48	25.38 [*]

Table 1. CC TOLERANCE (150 pcs)

*The main deviation factor is high temperature condition. The Total CC tolerance at 1% deep dimming condition without high temperature condition is less than 20%.



Figure 12. NCL30076 Dimming Curve and CC Tolerance

Standby Mode

Standby mode is triggered by V_{DIM} as shown in Figure 13.

- <u>A:</u> When V_{DIM} is lower than V_{DIM(SB-ENA)}, DRV is shut down. So, LED lamps turn off.
- <u>B:</u> After t_{SB(DELAY)} (10 ms), standby mode is entered and NCL30076 current consumption drops to I_{DD(SB)}.
- <u>C</u>: When V_{DIM} is higher than V_{DIM(SB-DIS)}, standby mode is immediately terminated and IC starts up.



Figure 13. NCL30076 Standby Mode

Soft Start

During soft start operation, Internal soft start counter $T_{OFF.SS}$ contributes to T_{OFF} by reduced from $t_{OFF(max)}$. When T_{OFF_SS} reaches to the steady state level, V_{FB} is settled to regulation level and T_{OFF} is finally decided to $T_{OFF.FB}$ or $T_{OFF.ZCD}$ by load condition. In the end of the soft start time, $T_{OFF.SS}$ reaches to 0 and doesn't affect T_{OFF} control anymore. Figure 14 shows how the soft start operates at full load condition where $T_{OFF.FB}$ is not engaged as T_{OFF} is set by $T_{OFF.ZCD}$ in QR mode.

- <u>A:</u> T_{OFF} is determined by T_{OFF.SS} which is reduced from t_{OFF(MAX)}. V_{FB} is pulled up and the system operates in DCM mode.
- <u>B:</u> T_{OFF} is controlled by T_{OFF.ZCD} as T_{OFF.SS} is shorter than T_{OFF.ZCD}. V_{LED} is closer to V_{REF}, and V_{FB} starts falling.
- <u>C:</u> V_{FB} is settled in regulation level and steady state starts.



Protections

- VDD Over Voltage Protection (OVP) When VDD is higher than V_{DD(OVP)} (23 V), VDD OVP is triggered with 1 sec AR timer. Open LED protection can be implemented by VDD OVP when VDD is supplied by auxiliary winding in the buck inductor.
- Over Current Protection (OCP) When CSZCD voltage is higher than V_{CS(OCP)} (1 V) after leading edge blanking time, t_{LEB(TON)} (400 ns), IC immediately shuts down with 1 sec AR timer.
- Short LED Protection (SLP) When LED load is short–circuited, T_{OFF} is lengthened to

1300 $\mu s, t_{OFF(MAX)}$ due to the absence of zero cross detection. Therefore, max. T_{OFF} control protects the freewheeling diode from thermal stress and the diode current is regulated close to the LED current set by $V_{DIM}.$

• Thermal Shut Down (TSD)

When the junction temperature is higher than T_{SD} , the system shuts down and the junction temperature is monitored at every 1 second AR delay time. When the temperature is lower than $T_{SD}-T_{SD(HYS)}$, the system restarts.

APPENDIX: DIMMING CURVE AND CC TOLERANCE WITH SYSTEM VARIABLES

- System: NCL30076 100 W (V_{IN}: 400 V / V_{OUT}: 100 ~ 300 V / I_{OUT(MAX)}: 333 mA)
- Temperature variation: –10 / 25 / 90 $^{\circ}\mathrm{C}$
- Inductance variation: $\pm 15\%$ (1.36 mH ~ 1.84 mH)
- Output Voltage: $100\/\ 200\/\ 300\ V$
- NCL35076 Controller: 150 pcs (3 lot variation)



Figure 15. CC Tolerance (150 pcs)

PCB LAYOUT GUIDANCE





RZCD1 should be properly selected according to rated voltage.

Figure 16. Layout Guidance

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*For additional information on our Pb-Free strategy and soldering details, please download the **onsemi** Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

STYLES ON PAGE 2

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STYLE 1: PIN 1. EMITTER COLLECTOR 2. COLLECTOR 3. 4. EMITTER 5. EMITTER BASE 6. 7 BASE EMITTER 8. STYLE 5: PIN 1. DRAIN 2. DRAIN З. DRAIN DRAIN 4. GATE 5. 6. GATE SOURCE 7. 8. SOURCE STYLE 9: PIN 1. EMITTER, COMMON COLLECTOR, DIE #1 COLLECTOR, DIE #2 2. З. EMITTER, COMMON 4. 5. EMITTER, COMMON 6 BASE. DIE #2 BASE, DIE #1 7. 8. EMITTER, COMMON STYLE 13: PIN 1. N.C. 2. SOURCE 3 GATE 4. 5. DRAIN 6. DRAIN DRAIN 7. 8. DRAIN STYLE 17: PIN 1. VCC 2. V2OUT V10UT З. TXE 4. 5. RXE 6. VFF 7. GND 8. ACC STYLE 21: PIN 1. CATHODE 1 2. CATHODE 2 3 CATHODE 3 CATHODE 4 4. 5. CATHODE 5 6. COMMON ANODE COMMON ANODE 7. 8. CATHODE 6 STYLE 25: PIN 1. VIN 2 N/C REXT З. 4. GND 5. IOUT 6. IOUT IOUT 7. 8. IOUT STYLE 29: BASE, DIE #1 PIN 1. 2 EMITTER, #1 BASE, #2 З. EMITTER, #2 4. 5 COLLECTOR, #2 COLLECTOR, #2 6.

STYLE 2: PIN 1. COLLECTOR, DIE, #1 2. COLLECTOR, #1 COLLECTOR, #2 3. 4 COLLECTOR, #2 BASE, #2 5. EMITTER, #2 6. 7 BASE #1 EMITTER, #1 8. STYLE 6: PIN 1. SOURCE 2. DRAIN 3. DRAIN SOURCE 4. SOURCE 5. 6. GATE GATE 7. 8. SOURCE STYLE 10: GROUND PIN 1. BIAS 1 OUTPUT 2. З. GROUND 4. 5. GROUND 6 BIAS 2 INPUT 7. 8. GROUND STYLE 14: PIN 1. N-SOURCE 2. N-GATE 3 P-SOURCE P-GATE 4. P-DRAIN 5 6. P-DRAIN N-DRAIN 7. N-DRAIN 8. STYLE 18: PIN 1. ANODE ANODE 2. SOURCE 3. GATE 4. 5. DRAIN 6 DRAIN CATHODE 7. 8. CATHODE STYLE 22: PIN 1. I/O LINE 1 2. COMMON CATHODE/VCC 3 COMMON CATHODE/VCC 4. I/O LINE 3 COMMON ANODE/GND 5. 6. I/O LINE 4 7. I/O LINE 5 8. COMMON ANODE/GND STYLE 26: PIN 1. GND 2 dv/dt З. ENABLE 4. ILIMIT 5. SOURCE SOURCE 6. SOURCE 7. 8. VCC STYLE 30: DRAIN 1 PIN 1. DRAIN 1 2 GATE 2 З. SOURCE 2 4. SOURCE 1/DRAIN 2 SOURCE 1/DRAIN 2 5. 6.

STYLE 3: PIN 1. DRAIN, DIE #1 DRAIN, #1 2. DRAIN, #2 З. DRAIN, #2 4. GATE, #2 5. SOURCE, #2 6. 7 GATE #1 8. SOURCE, #1 STYLE 7: PIN 1. INPUT 2. EXTERNAL BYPASS THIRD STAGE SOURCE GROUND З. 4. 5. DRAIN 6. GATE 3 SECOND STAGE Vd 7. FIRST STAGE Vd 8. STYLE 11: PIN 1. SOURCE 1 GATE 1 SOURCE 2 2. 3. GATE 2 4. 5. DRAIN 2 6. DRAIN 2 DRAIN 1 7. 8. DRAIN 1 STYLE 15: PIN 1. ANODE 1 2. ANODE 1 ANODE 1 3 ANODE 1 4. 5. CATHODE, COMMON CATHODE, COMMON CATHODE, COMMON 6. 7. CATHODE, COMMON 8. STYLE 19: PIN 1. SOURCE 1 GATE 1 SOURCE 2 2. 3. GATE 2 4. 5. DRAIN 2 6. MIRROR 2 7. DRAIN 1 8. **MIRROR 1** STYLE 23: PIN 1. LINE 1 IN COMMON ANODE/GND COMMON ANODE/GND 2. 3 LINE 2 IN 4. LINE 2 OUT 5. COMMON ANODE/GND COMMON ANODE/GND 6. 7. 8. LINE 1 OUT STYLE 27: PIN 1. ILIMIT 2 OVI 0 UVLO З. 4. INPUT+ 5. 6. SOURCE SOURCE SOURCE 7. 8 DRAIN

STYLE 4: PIN 1. 2. ANODE ANODE ANODE З. 4. ANODE ANODE 5. 6. ANODE 7 ANODE COMMON CATHODE 8. STYLE 8: PIN 1. COLLECTOR, DIE #1 2. BASE, #1 BASE #2 З. COLLECTOR, #2 4. COLLECTOR, #2 5. 6. EMITTER, #2 EMITTER, #1 7. 8. COLLECTOR, #1 STYLE 12: PIN 1. SOURCE SOURCE 2. 3. GATE 4. 5. DRAIN 6. DRAIN DRAIN 7. 8. DRAIN STYLE 16 EMITTER, DIE #1 PIN 1. 2. BASE, DIE #1 EMITTER, DIE #2 3 BASE, DIE #2 4. 5. COLLECTOR, DIE #2 6. COLLECTOR, DIE #2 COLLECTOR, DIE #1 7. COLLECTOR, DIE #1 8. STYLE 20: PIN 1. SOURCE (N) GATE (N) SOURCE (P) 2. 3. 4. GATE (P) 5. DRAIN 6. DRAIN DRAIN 7. 8. DRAIN STYLE 24: PIN 1. BASE EMITTER 2. 3 COLLECTOR/ANODE COLLECTOR/ANODE 4. 5. CATHODE

6. CATHODE COLLECTOR/ANODE 7. 8. COLLECTOR/ANODE STYLE 28: PIN 1. SW_TO_GND 2. DASIC OFF DASIC_SW_DET З. 4. GND 5. 6. V MON VBULK 7. VBULK

7. VOULK 8. VIN

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SOURCE 1/DRAIN 2

7.

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7.

8

COLLECTOR, #1

COLLECTOR, #1

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